

FLM1213-8F

X, Ku-Band Internally Matched FET

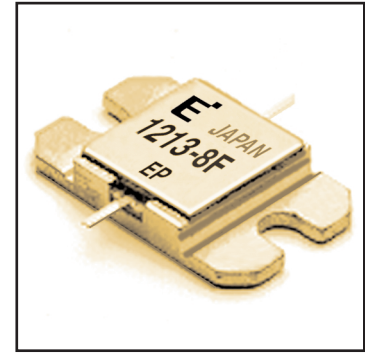
FEATURES

- High Output Power: $P_{1dB} = 39.0dBm$ (Typ.)
- High Gain: $G_{1dB} = 6.5dB$ (Typ.)
- High PAE: $\eta_{add} = 28%$ (Typ.)
- Low $IM_3 = -46dBc @ P_o = 28.5dBm$
- Broad Band: 12.7 ~ 13.2GHz
- Impedance Matched $Z_{in}/Z_{out} = 50\Omega$
- Hermetically Sealed

DESCRIPTION

The FLM1213-8F is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.

Eudyna's stringent Quality Assurance Program assures the highest reliability and consistent performance.



ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	V_{DS}		15	V
Gate-Source Voltage	V_{GS}		-5	V
Total Power Dissipation	P_T	$T_C = 25^\circ C$	42.8	W
Storage Temperature	T_{stg}		-65 to +175	$^\circ C$
Channel Temperature	T_{ch}		175	$^\circ C$

Fujitsu recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage (V_{DS}) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 32.0 and -4.4 mA respectively with gate resistance of 100Ω .

ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25^\circ C$)

Item	Symbol	Test Conditions	Limit			Unit	
			Min.	Typ.	Max.		
Saturated Drain Current	I_{DSS}	$V_{DS} = 5V, V_{GS} = 0V$	-	3400	5200	mA	
Transconductance	g_m	$V_{DS} = 5V, I_{DS} = 2200mA$	-	3400	-	mS	
Pinch-off Voltage	V_p	$V_{DS} = 5V, I_{DS} = 170mA$	-0.5	-1.5	-3.0	V	
Gate Source Breakdown Voltage	V_{GSO}	$I_{GS} = -170\mu A$	-5.0	-	-	V	
Output Power at 1dB G.C.P.	P_{1dB}	$V_{DS} = 10V$ $f = 12.7 \sim 13.2 GHz$ $I_{DS} = 0.65 I_{DSS}(Typ.)$ $Z_S = Z_L = 50\Omega$	38.5	39.0	-	dBm	
Power Gain at 1dB G.C.P.	G_{1dB}		5.5	6.5	-	dB	
Drain Current	I_{dsr}		-	2200	2600	mA	
Power-Added Efficiency	η_{add}		-	28	-	%	
Gain Flatness	ΔG		-	-	± 0.6	dB	
3rd Order Intermodulation Distortion	IM_3		$f = 13.2GHz, \Delta f = 10MHz$ 2-Tone Test $P_{out} = 28.5dBm S.C.L.$	-44	-46	-	dBc
Thermal Resistance	R_{th}		Channel to Case	-	3.0	3.5	$^\circ C/W$
Channel Temperature Rise	ΔT_{ch}	$10V \times I_{dsr} \times R_{th}$	-	-	80	$^\circ C$	

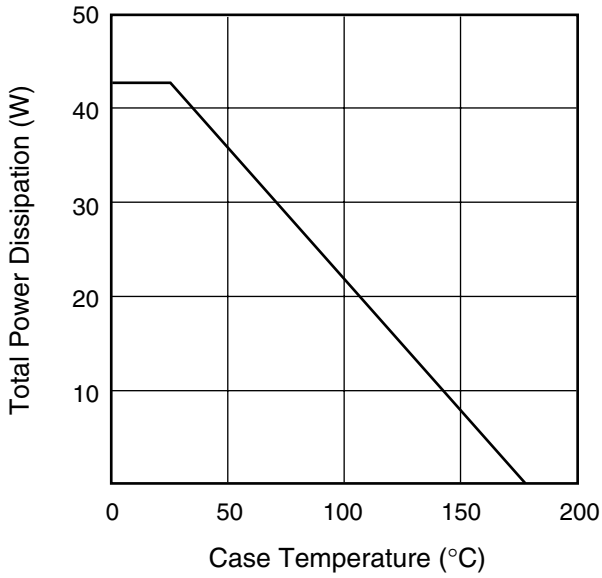
CASE STYLE: IA

G.C.P.: Gain Compression Point, S.C.L.: Single Carrier Level

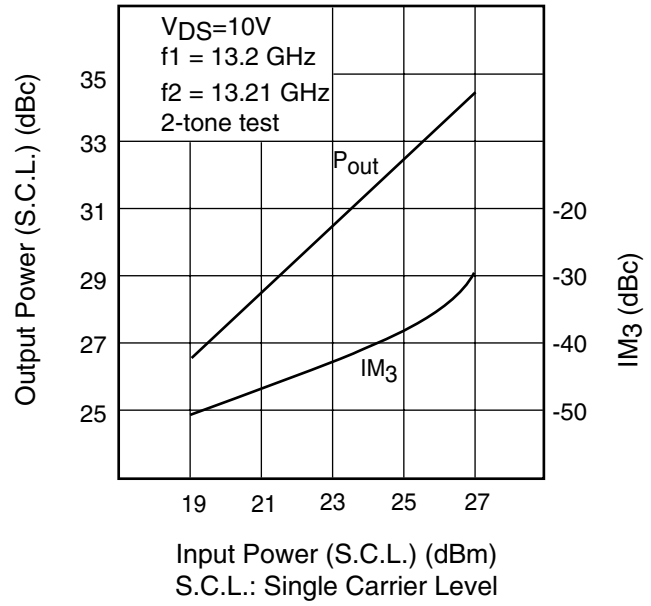
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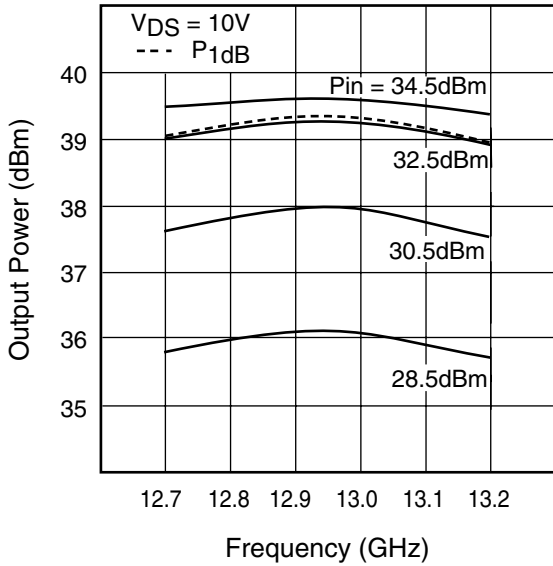
POWER DERATING CURVE



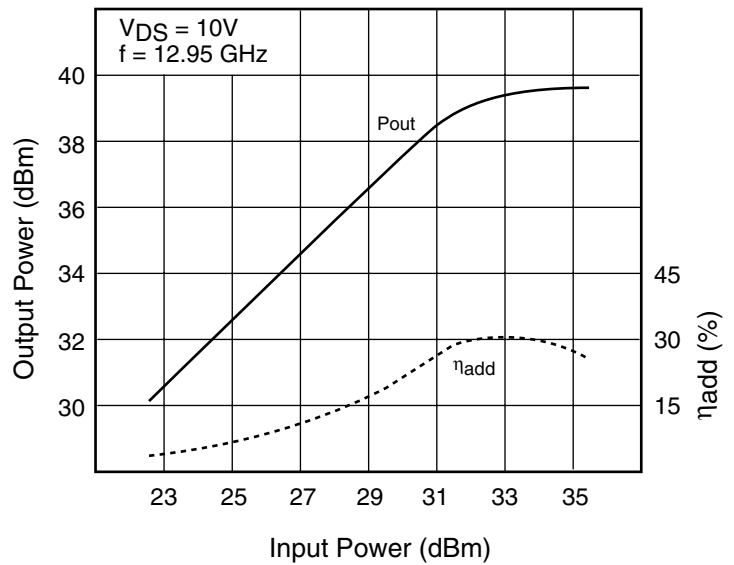
OUTPUT POWER & IM₃ vs. INPUT POWER



OUTPUT POWER vs. FREQUENCY

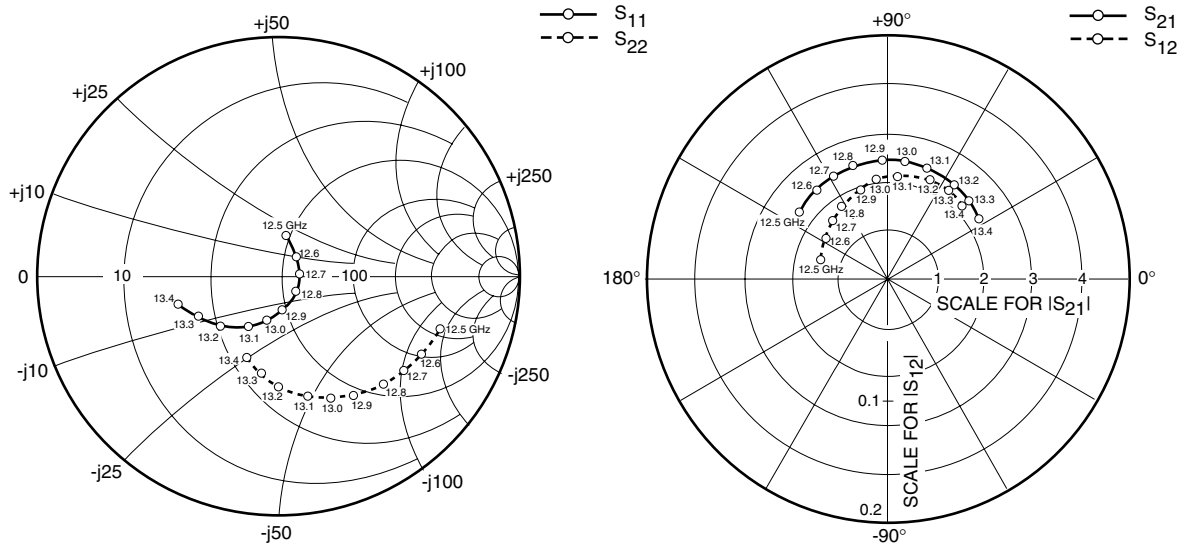


OUTPUT POWER vs. INPUT POWER



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S-PARAMETERS

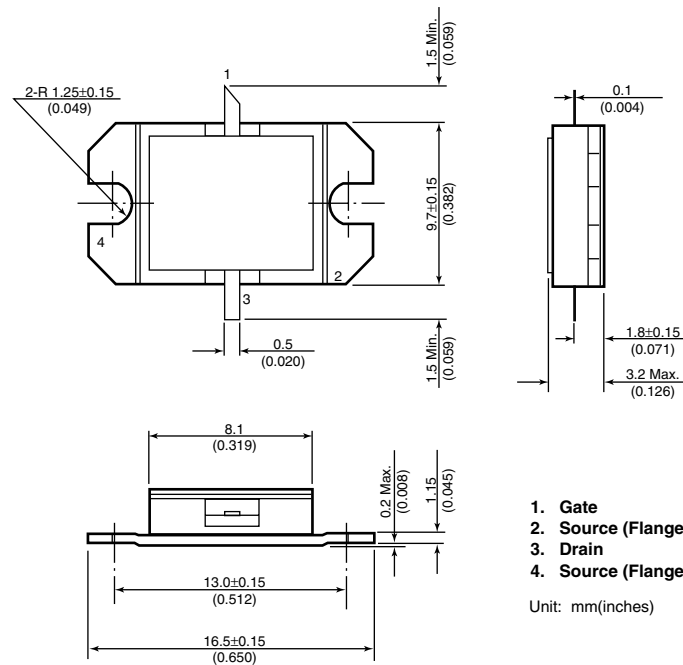
$V_{DS} = 10V, I_{DS} = 2200mA$

FREQUENCY (MHZ)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
12500	.171	81.0	2.291	143.6	.059	163.7	.710	-18.0
12600	.109	47.9	2.344	129.3	.061	148.1	.681	-28.4
12700	.084	6.1	2.399	118.7	.068	134.6	.658	-36.7
12800	.094	-44.1	2.443	107.7	.071	122.9	.633	-45.3
12900	.143	-85.2	2.455	93.1	.076	107.5	.592	-57.1
13000	.194	-105.7	2.443	82.2	.082	97.0	.556	-66.3
13100	.248	-121.5	2.410	70.8	.084	85.3	.516	-75.7
13200	.322	-140.0	2.371	55.3	.089	67.2	.458	-89.4
13300	.373	-153.0	2.317	44.1	.088	55.7	.411	-99.3
13400	.432	-164.4	2.239	32.6	.086	44.5	.362	-110.1

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Case Style "IA" Metal-Ceramic Hermetic Package



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CAUTION

Eudyna Devices Inc. products contain **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

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